

PATENT ASSIGNMENT

Electronic Version v1.1
 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Po Tong	09/01/2011
Ivana Djurdjevic	09/02/2011
Damien Latremouille	09/02/2011
Francesco Caggioni	09/02/2011
Dariush Dabiri	09/02/2011
RECEIVING PARTY DATA	
Name:	Applied Micro Circuits Corporation
Street Address:	9868 Scranton Road
Internal Address:	Suite 1200
City:	San Diego
State/Country:	CALIFORNIA
Postal Code:	92121
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	13225337
CORRESPONDENCE DATA	
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Address Line 4:	San Jose, CALIFORNIA 95117
ATTORNEY DOCKET NUMBER:	AMC032 US

OP \$40.00 13225337

501647767

**PATENT
 REEL: 026854 FRAME: 0091**

NAME OF SUBMITTER:

Omkar K. Suryadevara

Total Attachments: 10

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ASSIGNMENT

For good and valuable consideration, receipt of which is hereby acknowledged, I:

Po Tong of 435 Almond Avenue, Los Altos, CA 94022;

Ivana Djurdjevic of 10444 B Lockwood Drive, Cupertino, CA 95014;

Damien Latremouille of 16 Whitestone Dr, Ottawa, Ontario, Canada K2C 4A7;

Francesco Caggioni of 160 Mount Vernon Street, Winchester, MA 01890;

Darush Dabiri of 1421 Calle Alegre, San Jose, California, CA 95128;

hereby sell, assign and transfer to Applied Micro Circuits Corporation, a Delaware corporation, having a place of business at 9868 Scranton Road, Suite 1200, San Diego, CA 92121, its successors and assigns, the entire right, title and interest throughout the world in my invention for which I have executed a United States patent application entitled

**SYMMETRIC DIAGONAL INTERLEAVING
AND ENCODING/DECODING CIRCUIT AND METHOD**

the patent application being executed on or about the date of this assignment, and all patent applications and patents of every country for said invention, including divisions, reissues, continuations and extensions thereof, and all rights of priority resulting from the filing of said applications; I authorize the above-named assignee to apply for patents of foreign countries for said invention, and to claim all rights of priority without further authorization from me; I agree to execute all papers useful in connection with said United States and foreign applications, and generally to do everything possible to aid said assignee, its successors, assigns and nominees, at their request and expense, in obtaining and enforcing patents for said invention in all countries; and I request that the United States Patent and Trademark Office issue all patents granted for said invention to the above-named assignee, its successors and assigns.

First Joint Inventor

Executed this 1st day of September, 2011.

Signature of Po Tong

Second Joint Inventor

Executed this _____ day of _____, 2011.

Signature of Ivana Djurdjevic

Third Joint Inventor

Executed this ____ day of _____, 2011.

Signature of **Damien Latremouille**

Fourth Joint Inventor

Executed this ____ day of _____, 2011.

Signature of **Francesco Caggioni**

Fifth Joint Inventor

Executed this ____ day of _____, 2011.

Signature of **Dariusz Dabiri**

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First Joint Inventor

Executed this _____ day of _____, 2011.

Signature of **Po Tong**

Second Joint Inventor

Executed this 2nd day of September, 2011.

Signature of **Ivana Djurdjevic**

Third Joint Inventor

Executed this _____ day of _____, 2011.

Signature of **Damien Latremouille**

Fourth Joint Inventor

Executed this _____ day of _____, 2011.

Signature of **Francesco Caggioni**

Fifth Joint Inventor

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Signature of **Dariusb Dabiri**

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First Joint Inventor

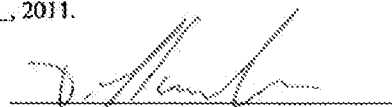
Executed this _____ day of _____, 2011. _____ Signature of Po Tong
--

Second Joint Inventor

Executed this _____ day of _____, 2011. _____ Signature of Ivana Djurdjevic

Third Joint Inventor

Executed this 2nd day of September, 2011.


Signature of Damien Latremouille

Fourth Joint Inventor

Executed this _____ day of _____, 2011.

Signature of Francesco Caggioni

Fifth Joint Inventor

Executed this _____ day of _____, 2011.

Signature of Darinsh Dabiri

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_____ Signature of Po Tong

Second Joint Inventor

Executed this _____ day of _____, 2011.
_____ Signature of Ivana Djurdjevic

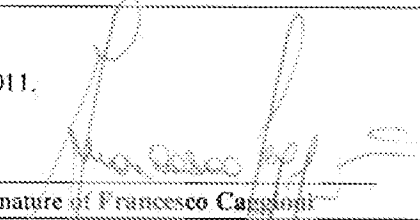
Third Joint Inventor

Executed this _____ day of _____, 2011.

Signature of Damien Latremouille

Fourth Joint Inventor

Executed this 2 day of SEPTEMBER, 2011.



Signature of Francesco Caporali

Fifth Joint Inventor

Executed this _____ day of _____, 2011.

Signature of Dariush Dabiri

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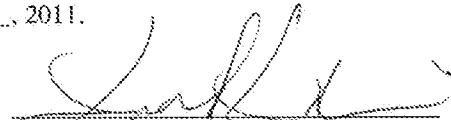
Fourth Joint Inventor

Executed this _____ day of _____, 2011.

Signature of Francesco Caggioni

Fifth Joint Inventor

Executed this 2 day of Sept, 2011.



Signature of Dariush Dabiri